

Metallized Paper (MP) RFI-Capacitors Class Y2 PCM 10 mm and 15 mm

Special Features

- Particularly high reliability against active and passive flammability
- Excellent self-healing as well as high voltage strength
- High degree of interference suppression due to good attenuation and low ESR
- For temperatures up to +110° C
- According to RoHS 2002/95/EC

Typical Applications

Class Y2 RFI applications to meet EMC regulations

- Capacitors connected to the mains between phase or neutral and earthed casing
- By-passing of the basic or supplementary insulation, pulse peak voltage ≤ 5 kV

Construction

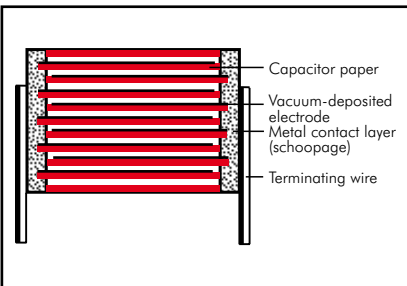
Dielectric:

Paper, epoxy resin impregnated

Capacitor electrodes:

Vacuum-deposited

Internal construction:



Encapsulation:

Self-extinguishing epoxy resin, UL 94 V-0 metal foil

Terminations:

Tinned wire.

Marking:

Marking: Black on Silver.

Electrical Data

Capacitance range:

1000 pF to 0.022 μ F (E12-values on request)

Rated voltage:

250 VAC

Continuous DC voltage* (general guide):

≤ 1000 V

Capacitance tolerances:

$\pm 20\%$

Operating temperature range:

-40° C to $+110^{\circ}$ C

Climatic test category:

40/110/56/C in accordance with IEC

Insulation resistance at $+20^{\circ}$ C:

$\geq 12 \times 10^3$ M Ω

Measuring voltage: 100 V/1 min.

Dissipation factors:

$\tan \delta \leq 13 \times 10^{-3}$ at 1 kHz and $+20^{\circ}$ C

Test specifications:

In accordance with DIN EN 60384-14

Approvals:

Country	Authority	Specification	Symbol	Approval-No.
Germany	VDE	DIN EN 132 400 IEC 60384-14/2		87455
USA	UL	UL 1283		E 100438
Canada	CSA	C 22.2 No. 8		LR 93312-1

Maximum pulse rise time:

Capacitance pF/ μ F	Pulse rise time V/ μ sec max. operation
1000	1100
1500	1100
2200 ... 4700	500
6800 ... 0.022	300

for pulses equal to a voltage amplitude with $\sqrt{2} \times 250$ VAC = 355 V according to IEC 60384-14

Test voltage: 2700 VDC, 2 sec.

Reliability:

Operational life > 300 000 hours

Failure rate < 1 fit ($0.5 \times U_r$ and 40° C)

* If safety-approved EMI suppression capacitors are operated with a DC voltage being above the specified AC voltage rating the given approvals are no longer valid (DIN EN 60384-14).

Furthermore the permissible pulse rise time du/dt ($F_{max.}$) will be subject to a reduction according to

$$F_{max.} = F_r \times \sqrt{2} \times UAC / UDC$$

if the DC operating voltage UDC is higher than $\sqrt{2} \times UAC$

Packing

Available taped and reeled.

Detailed taping information and graphs at the end of the catalogue.

For further details and graphs please refer to Technical Information.

Continuation

General Data

Capacitance	250 VAC*			
	W	H	L	PCM**
1000 pF	4	8.5	13.5	10
1500 „	4	8.5	13.5	10
2200 „	4	8.5	13.5	10
3300 „	4	8.5	13.5	10
4700 „	5	10	13.5	10
6800 „	5	13	19	15
0.01 μ F	5	13	19	15
0.015 „	6	14	19	15
0.022 „	7	15	19	15

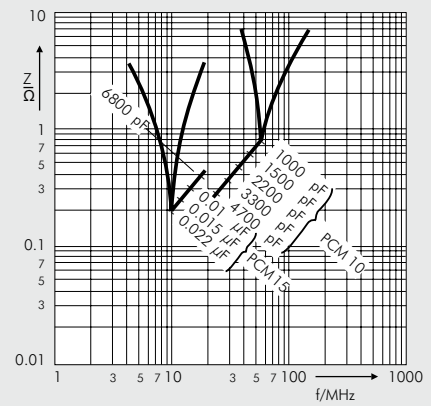
* $f = 50/60$ Hz

** PCM = Printed circuit module = lead spacing

Upon request with long leads 35-2 mm max.

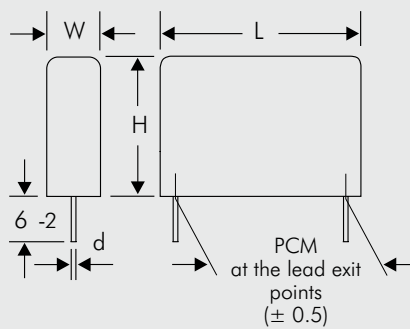
Dims. in mm.

Taped version see page 121.



Impedance change with frequency (general guide)

$d = 0.6 \varnothing$ if PCM 10
 $d = 0.8 \varnothing$ if PCM 15



Rights reserved to amend design data without prior notification.

Recommendation for Processing and Application of Through-Hole Capacitors

Soldering Process

A preheating of through-hole WIMA capacitors is allowed for temperatures $T_{\max} < 100^{\circ}\text{C}$. In practice a preheating duration of $t < 5$ min. has been proven to be best.

Single wave soldering

Soldering bath temperature: $T < 260^{\circ}\text{C}$
Immersion time: $t < 5$ sec

Double wave soldering

Soldering bath temperature: $T < 260^{\circ}\text{C}$
Immersion time: $2 \times t < 3$ sec

Due to different soldering processes and heat requirements the graphs are to be regarded as a recommendation only.



WIMA Quality and Environmental Philosophy

ISO 9001:2000 Certification

ISO 9001:2000 is an international basic standard of quality assurance systems for all branches of industry. The approval according to ISO 9001:2000 of our factories by the VDE inspectorate certifies that organisation, equipment and monitoring of quality assurance in our factories correspond to internationally recognized standards.

WIMA WPCS

The WIMA Process Control System (WPCS) is a quality surveillance and optimization system developed by WIMA. WPCS is a major part of the quality-oriented WIMA production. Points of application of WPCS during production process:

- incoming material inspection
- metallization
- film inspection
- schoopage
- pre-healing
- lead attachment
- cast resin preparation/encapsulation
- 100% final inspection
- AQL check

WIMA Environmental Policy

All WIMA capacitors, irrespective of whether through-hole devices or SMD, are made of environmentally friendly materials. Neither during manufacture nor in the product itself any toxic substances are used, e.g.

- Lead
- PCB
- CFC
- Hydrocarbon chloride
- Chromium 6+
- PBB/PBDE
- Arsenic
- Cadmium
- Mercury
- etc.

We merely use pure, recyclable materials for packing our components, such as:

- carton
- cardboard
- adhesive tape made of paper
- polystyrene

We almost completely refrain from using packing materials such as:

- foamed polystyrene (Styropor®)
- adhesive tapes made of plastic
- metal clips

RoHS Compliance

According to the RoHS Directive 2002/95/EC certain hazardous substances like e.g. lead, cadmium, mercury must not be used any longer in electronic equipment as of July 1st, 2006. For the sake of the environment WIMA has refrained from using such substances since years already.



WIMA Kondensatoren sind bleifrei konform RoHS 2002/95/EG

WIMA capacitors are lead free in accordance with RoHS 2002/95/EC

Tape for lead-free WIMA capacitors

DIN EN ISO 14001:2005

WIMA's environmental management has been established in accordance with the guidelines of DIN EN ISO 14001:2005. The certification has been granted in June 2006.

Typical Dimensions for Taping Configuration

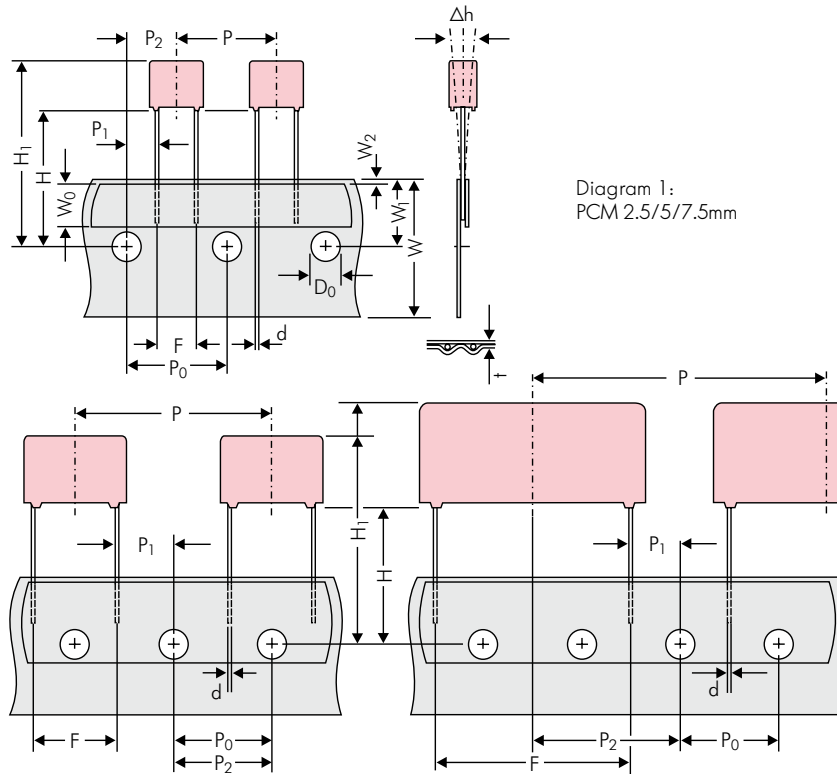


Diagram 1:
PCM 2.5/5/7.5mm

Diagram 2: PCM 10/15 mm

Diagram 3: PCM 22.5 and 27.5*mm

*PCM 27.5 tapping possible with two feed holes between components

Designation	Symbol	Dimensions for Radial Taping						
		PCM 2.5 tapping	PCM 5 tapping	PCM 7.5 tapping	PCM 10 tapping*	PCM 15 tapping*	PCM 22.5 tapping	PCM 27.5 tapping
Carrier tape width	W	18.0 ±0.5	18.0 ±0.5	18.0 ±0.5	18.0 ±0.5	18.0 ±0.5	18.0 ±0.5	18.0 ±0.5
Hold-down tape width	W ₀	6.0 for hot-sealing adhesive tape	6.0 for hot-sealing adhesive tape	12.0 for hot-sealing adhesive tape	12.0 for hot-sealing adhesive tape	12.0 for hot-sealing adhesive tape	12.0 for hot-sealing adhesive tape	12.0 for hot-sealing adhesive tape
Hole position	W ₁	9.0 ±0.5	9.0 ±0.5	9.0 ±0.5	9.0 ±0.5	9.0 ±0.5	9.0 ±0.5	9.0 ±0.5
Hold-down tape position	W ₂	0.5 to 3.0 max.	0.5 to 3.0 max.	0.5 to 3.0 max.	0.5 to 3.0 max.	0.5 to 3.0 max.	0.5 to 3.0 max.	0.5 to 3.0 max.
Feed hole diameter	D ₀	4.0 ±0.2	4.0 ±0.2	4.0 ±0.2	4.0 ±0.2	4.0 ±0.2	4.0 ±0.2	4.0 ±0.2
Pitch of component	P	12.7 ±1.0	12.7 ±1.0	12.7 ±1.0	25.4 ±1.0	25.4 ±1.0	38.1 ±1.5	38.1 ±1.5 or 50.8 ±1.5
Feed hole pitch	P ₀	12.7 ±0.3 cumulative pitch error max. 1.0 mm/20 pitch	12.7 ±0.3 cumulative pitch error max. 1.0 mm/20 pitch	12.7 ±0.3 cumulative pitch error max. 1.0 mm/20 pitch	12.7 ±0.3 cumulative pitch error max. 1.0 mm/20 pitch	12.7 ±0.3 cumulative pitch error max. 1.0 mm/20 pitch	12.7 ±0.3 cumulative pitch error max. 1.0 mm/20 pitch	12.7 ±0.3 cumulative pitch error max. 1.0 mm/20 pitch
Feed hole centre to lead	P ₁	5.1 ±0.5	3.85 ±0.7	2.6 ±0.7	7.7 ±0.7	5.2 ±0.7	7.8 ±0.7	5.3 ±0.7
Hole centre to component centre	P ₂	6.35 ±1.3	6.35 ±1.3	6.35 ±1.3	12.7 ±1.3	12.7 ±1.3	19.05 ±1.3	19.05 ±1.3
Feed hole centre to bottom edge of the component	H _▲	16.5 ±0.3 18.5 ±0.5	16.5 ±0.3 18.5 ±0.5	16.5 ±0.5 18.5 ±0.5	16.5 ±0.5 18.5 ±0.5	16.5 ±0.5 18.5 ±0.5	16.5 ±0.5 18.5 ±0.5	16.5 ±0.5 18.5 ±0.5
Feed hole centre to top edge of the component	H ₁	H+H _{component} < H ₁ 32.25 max.	H+H _{component} < H ₁ 32.25 max.	H+H _{component} < H ₁ 24.5 to 31.5	H+H _{component} < H ₁ 25.0 to 31.5	H+H _{component} < H ₁ 26.0 to 37.0	H+H _{component} < H ₁ 30.0 to 43.0	H+H _{component} < H ₁ 35.0 to 45.0
Lead spacing at upper edge of carrier tape	F	2.5 ±0.5	5.0 ^{+0.8} _{-0.2}	7.5 ±0.8	10.0 ±0.8	15 ±0.8	22.5 ±0.8	27.5 ±0.8
Lead diameter	d	0.4 ±0.05	0.5 ±0.05	0.5 ±0.05 or 0.6 ^{+0.06} _{-0.05}	0.5 ±0.05 or 0.6 ^{+0.06} _{-0.05}	0.8 ^{+0.08} _{-0.05}	0.8 ^{+0.08} _{-0.05}	0.8 ^{+0.08} _{-0.05}
Component alignment	Δh	± 2.0 max.	± 2.0 max.	± 3.0 max.	± 3.0 max.	± 3.0 max.	± 3.0 max.	± 3.0 max.
Total tape thickness	t	0.7 ±0.2	0.7 ±0.2	0.7 ±0.2	0.7 ±0.2	0.7 ±0.2	0.7 ±0.2	0.7 ±0.2
Package (see also page 122)	▲	ROLL/AMMO			AMMO			
		REEL ø 360 max. ø 30 ±1	B 52 ±2 58 ±2 } depending on comp. dimensions		REEL ø 360 max. ø 30 ±1	52 ±2 58 ±2 or 66 ±2	REEL ø 500 max. ø 25 ±1	54 ±2 60 ±2 68 ±2 } depending on PCM and component dimensions
Unit		see details page 124.						

▲ Please give „H“ dimensions and desired packaging type when ordering.

Dims in mm.

• Diameter of leads see General Data.

Please clarify customer-specific deviations with the manufacturer.

* PCM 10 and PCM 15 can be crimped to PCM 7.5.

Position of components according to PCM 7.5 (sketch 11). P₀ = 12.7 or 15.0 is possible